

IN THE CLAIMS:

1. (currently amended) An electronic component comprising:
a piezoelectric element having electrodes at two end portions thereof; and
at least a pair of lead terminals having cup-shaped holder portions arranged to hold both end portions of the piezoelectric element;
a conductive joining material arranged such that the cup-shaped holder portions and the electrodes disposed at both end portions of the piezoelectric element are electrically and mechanically connected by the conductive joining material; and
wherein each of the at least a pair of lead terminals are made of is defined by a conductive wire having a diameter, one end portion of each of the at least a pair of the lead terminals is includes a portion that is bent at a bending point outwards at an angle of about 90 degrees with respect to a lead portion of a respective one of said at least a pair of lead terminals, a flat portion is defined by a press extended portion on the a tip side from the bending point so as to be extended substantially parallel to a the lead portion of each of the pair of lead terminals, ~~and the flat portion includes a portion that is bent inwardly with respect to the portion that is bent outward at an angle of about 90 degrees to define the cup-shaped holder portion is defined by the flat portion being bent inwards~~, and the flat portion has a thickness that is less than about 50% of the diameter of the conductive wire.
2. (original) An electronic component according to Claim 1, wherein the electronic component is a resonator.
3. (original) An electronic component according to Claim 1, wherein the at least a pair of lead terminals comprises three lead terminals.
4. (original) An electronic component according to Claim 1, further comprising a packaging resin, wherein the piezoelectric element, the at least a pair of lead terminals

and the conductive joining material are sealed within the packaging resin.

5. (original) An electronic component according to Claim 1, wherein the piezoelectric element is an energy trap thickness shear vibration mode element.

6. (original) An electronic component according to Claim 1, wherein each of the at least a pair of lead terminals are made of a round lead wire of about 0.48 mm in diameter.

7. (original) An electronic component according to Claim 1, wherein each of the at least a pair of lead terminals includes a wire made of a low-carbon steel and having copper plated on a surface thereof and a molten solder plated on the copper plating.

8. (original) An electronic component according to Claim 1, wherein a width of the flat portions is about 0.8 mm to about 1.0 mm and a thickness of the flat portions is about 0.15 mm to about 0.2 mm.

9. (original) An electronic component according to Claim 1, wherein one of the at least a pair of terminals includes a middle terminal that is bent so as to have a step-like configuration.

10. (original) An electronic component according to Claim 1, further comprising a capacitor element held between the cup-shaped holder portions and a tip portion of one of the lead terminals, and is electrically and mechanically connected to the holder portions the conductive joining material.

11-21 (canceled)